TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC191AP, TC74HC191AF

4-Bit Binary Up/Down Counter

The TC74HC191A are high speed CMOS 4-BIT UP/DOWN COUNTERs fabricated with silicon gate C^2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The TC74HC191A is 4-bit binary up/down counter.

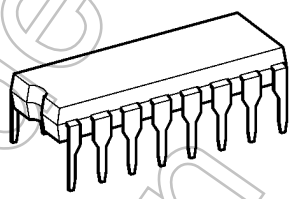
They have an asynchronous load input ($\overline{\text{LOAD}}$) which is active low.

The direction of counting is determined by the level of DOWN/UP. When D/U is low, the counter counts up; when D/U is high, it counts down. Counting occurs on the positive going transition of the clock input.

Enable input ($\overline{\text{ENABLE}}$) and two carry inputs (RIPPLE CLOCK OUT, MAX/MIN) are provided to permit easy cascading of the counters, which facilitates easy implementation of N-bit counters without using external gates.

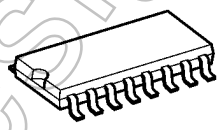
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

TC74HC191AP



DIP16-P-300-2.54A

TC74HC191AF



SOP16-P-300-1.27A

Weight

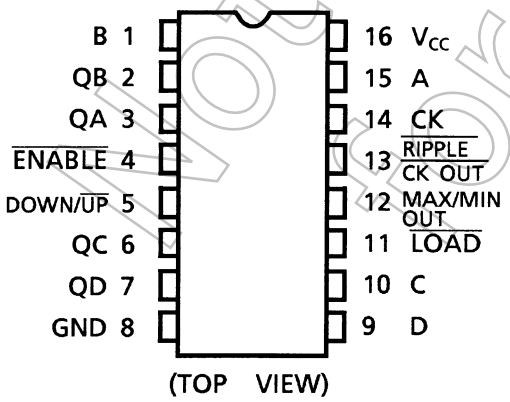
DIP16-P-300-2.54A : 1.00 g (typ.)

SOP16-P-300-1.27A : 0.18 g (typ.)

Features

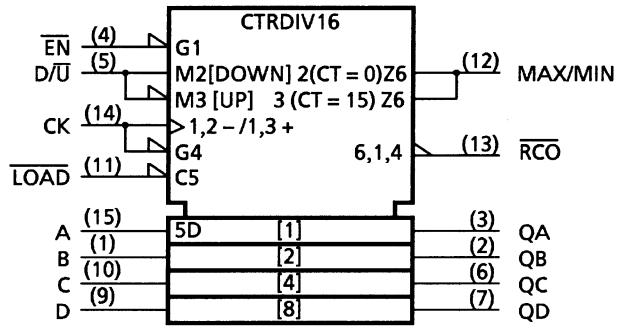
- High speed: fmax = 48 MHz (typ.) at V_{CC} = 5 V
- Low power dissipation: I_{CC} = 4 μA (max) at Ta = 25°C
- High noise immunity: $V_{NIH} = V_{NIL}$ = 28% V_{CC} (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: $|I_{OH}| = I_{OL}$ = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2 to 6 V
- Pin and function compatible with 74LS191

Pin Assignment



Start of commercial production
1988-11

IEC Logic Symbol



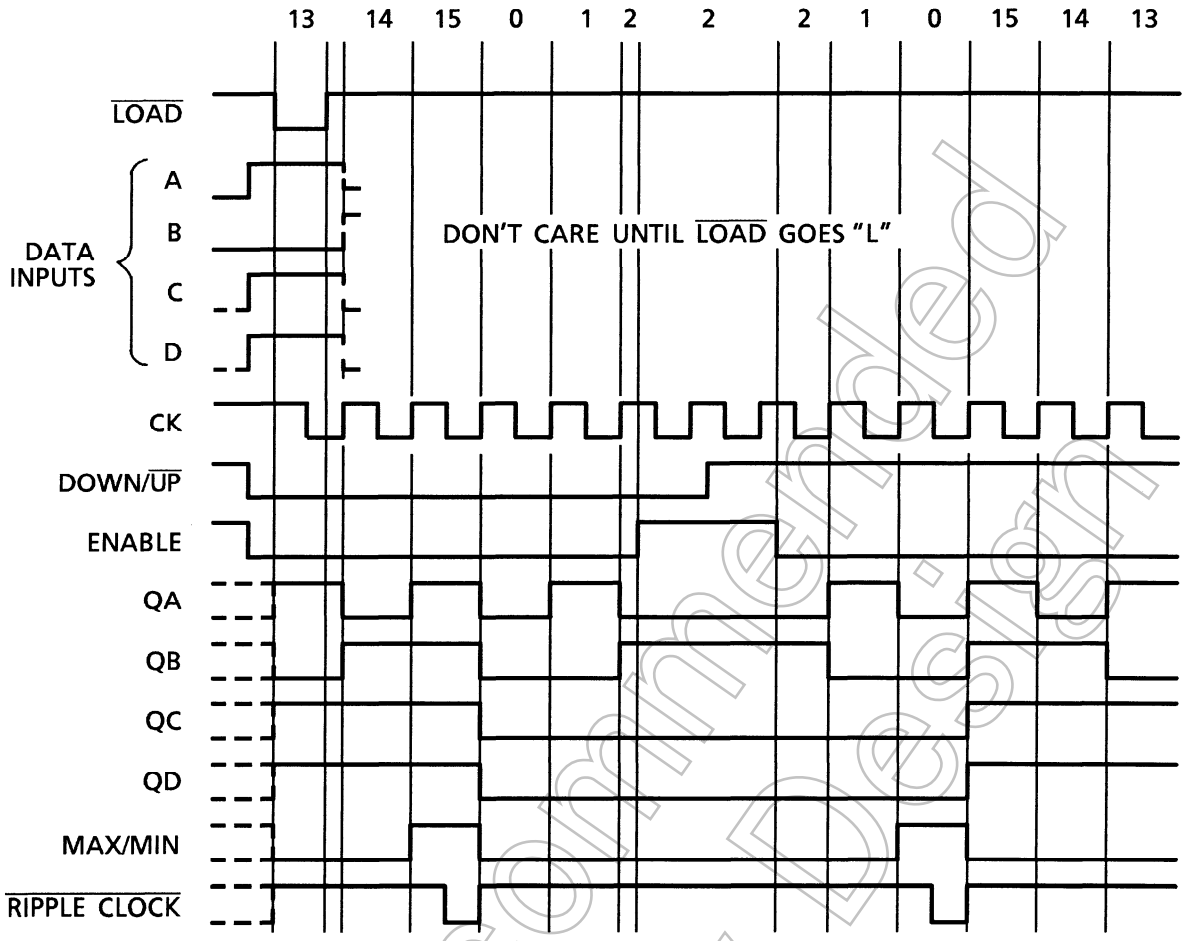
Truth Table

Inputs				Outputs				Function
$\overline{LOAD}$	$\overline{ENABLE}$	D/$\overline{U}$	CK	QA	QB	QC	QD	
L	X	X	X	a	b	c	d	Preset Data
H	L	L	↑	Up Count				Up Count
H	L	H	↑	Down Count				Down Count
H	H	X	↑	No Change				No Count
H	X	X	↓	No Change				No Count

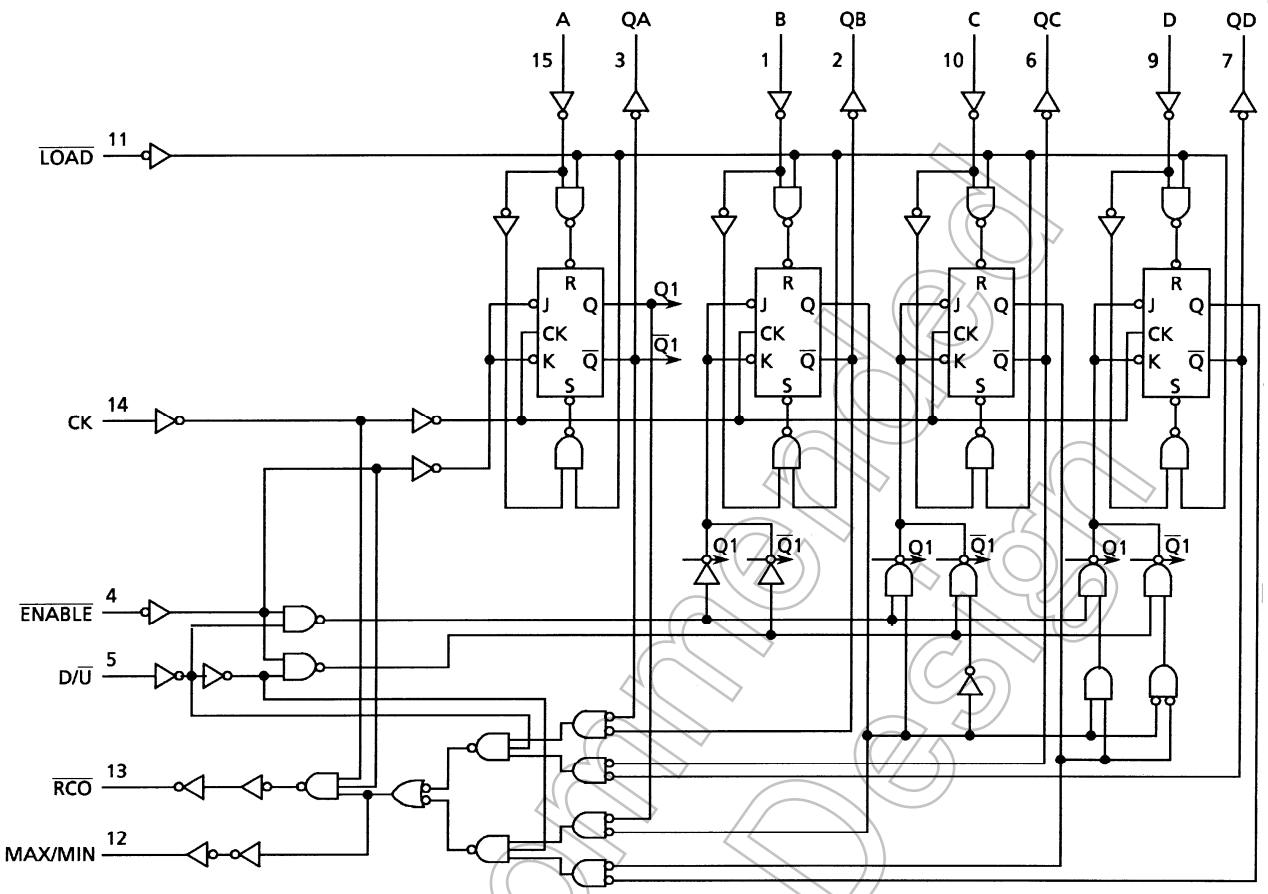
X: Don't care

a to d: Inputs level of A to D

Timing Chart



System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7	V
DC input voltage	V_{IN}	−0.5 to V_{CC} + 0.5	V
DC output voltage	V_{OUT}	−0.5 to V_{CC} + 0.5	V
Input diode current	I_{IK}	±20	mA
Output diode current	I_{OK}	±20	mA
DC output current	I_{OUT}	±25	mA
DC V_{CC}/ground current	I_{CC}	±50	mA
Power dissipation	P_D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T_{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = −40 to 65°C. From Ta = 65 to 85°C a derating factor of −10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2 to 6	V
Input voltage	V_{IN}	0 to V_{CC}	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	−40 to 85	°C
Input rise and fall time	t_r, t_f	0 to 1000 (V_{CC} = 2.0 V) 0 to 500 (V_{CC} = 4.5 V) 0 to 400 (V_{CC} = 6.0 V)	ns

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		V_{CC} (V)	Ta = 25°C Min	Ta = 25°C Typ.	Ta = 25°C Max	Ta = −40 to 85°C Min	Ta = −40 to 85°C Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	—	1.50	—	V
				4.5	3.15	—	—	3.15	—	
				6.0	4.20	—	—	4.20	—	
Low-level input voltage	V_{IL}	—		2.0	—	—	0.50	—	0.50	V
				4.5	—	—	1.35	—	1.35	
				6.0	—	—	1.80	—	1.80	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = −20 μA	2.0	1.9	2.0	—	1.9	—	V
				4.5	4.4	4.5	—	4.4	—	
				6.0	5.9	6.0	—	5.9	—	
			I_{OH} = −4 mA	4.5	4.18	4.31	—	4.13	—	
			I_{OH} = −5.2 mA	6.0	5.68	5.80	—	5.63	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 20 μA	2.0	—	0.0	0.1		0.1	V
				4.5	—	0.0	0.1	—	0.1	
				6.0	—	0.0	0.1	—	0.1	
			I_{OL} = 4 mA	4.5	—	0.17	0.26	—	0.33	
			I_{OL} = 5.2 mA	6.0	—	0.18	0.26	—	0.33	
Input leakage current	I_{IN}	V_{IN} = V_{CC} or GND		6.0	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		6.0	—	—	4.0	—	40.0	μA

Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = −40 to 85°C	Unit
			V_{CC} (V)	Typ.	Limit	Limit	
Minimum pulse width (CK)	$t_{W(H)}$ / $t_{W(L)}$	—	2.0	—	100	125	ns
			4.5	—	20	25	
			6.0	—	17	21	
Minimum pulse width ($\overline{LOAD}$)	$t_{W(L)}$	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum set-up time ($\overline{ENABLE}$, D/$\overline{U}$)	t_s	—	2.0	—	150	190	ns
			4.5	—	30	38	
			6.0	—	26	33	
Minimum set-up time (DATA-$\overline{LOAD}$)	t_s	—	2.0	—	50	65	ns
			4.5	—	10	13	
			6.0	—	9	11	
Minimum hold time ($\overline{ENABLE}$, D/$\overline{U}$)	t_h	—	2.0	—	0	0	ns
			4.5	—	0	0	
			6.0	—	0	0	
Minimum hold time (DATA-$\overline{LOAD}$)	t_h	—	2.0	—	0	0	ns
			4.5	—	0	0	
			6.0	—	0	0	
Minimum removal time	t_{rem}	—	2.0	—	50	65	ns
			4.5	—	10	13	
			6.0	—	9	11	
Clock frequency	f	—	2.0	—	5	4	MHz
			4.5	—	25	20	
			6.0	—	29	24	

AC Characteristics (C_L = 15 pF, V_{CC} = 5 V, Ta = 25°C, input: $t_r = t_f$ = 6 ns)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Output transition time	t_{TLH} t_{THL}	—	—	4	8	ns
Propagation delay time (CK-Q)	t_{pLH} t_{pHL}	—	—	18	31	ns
Propagation delay time (CK-$\overline{RCO}$)	t_{pLH} t_{pHL}	—	—	10	20	ns
Propagation delay time (CK-MAX/MIN)	t_{pLH} t_{pHL}	—	—	23	42	ns
Propagation delay time ($\overline{LOAD}$-Q)	t_{pLH} t_{pHL}	—	—	21	35	ns
Propagation delay time (DATA-Q)	t_{pLH} t_{pHL}	—	—	17	30	ns
Propagation delay time ($\overline{ENABLE}$ - $\overline{RCO}$)	t_{pLH} t_{pHL}	—	—	11	17	ns
Propagation delay time (D/$\overline{U}$ - $\overline{RCO}$)	t_{pLH} t_{pHL}	—	—	17	31	ns
Propagation delay time (D/$\overline{U}$ -MAX/MIN)	t_{pLH} t_{pHL}	—	—	15	27	ns
Maximum clock frequency	f_{max}	—	27	48	—	MHz

AC Characteristics (C_L = 50 pF, input: $t_r = t_f$ = 6 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
			V_{CC} (V)	Min	Typ.	Max	Min	Max	
Output transition time	t_{TLH} t_{THL}	—	2.0	—	30	75	—	95	ns
			4.5	—	8	15	—	19	
			6.0	—	7	13	—	16	
Propagation delay time (CK-Q)	t_{pLH} t_{pHL}	—	2.0	—	88	180	—	225	ns
			4.5	—	22	36	—	45	
			6.0	—	19	31	—	38	
Propagation delay time (CK-$\overline{RCO}$)	t_{pLH} t_{pHL}	—	2.0	—	52	120	—	150	ns
			4.5	—	13	24	—	30	
			6.0	—	11	20	—	26	
Propagation delay time (CK-MAX/MIN)	t_{pLH} t_{pHL}	—	2.0	—	108	240	—	300	ns
			4.5	—	27	48	—	60	
			6.0	—	23	41	—	51	
Propagation delay time ($\overline{LOAD}$-Q)	t_{pLH} t_{pHL}	—	2.0	—	100	205	—	255	ns
			4.5	—	25	41	—	51	
			6.0	—	22	35	—	43	
Propagation delay time (DATA-Q)	t_{pLH} t_{pHL}	—	2.0	—	84	175	—	220	ns
			4.5	—	21	35	—	44	
			6.0	—	18	30	—	37	
Propagation delay time ($\overline{ENABLE}$ - $\overline{RCO}$)	t_{pLH} t_{pHL}	—	2.0	—	56	105	—	130	ns
			4.5	—	14	21	—	26	
			6.0	—	12	18	—	22	
Propagation delay time (D/$\overline{U}$ - $\overline{RCO}$)	t_{pLH} t_{pHL}	—	2.0	—	84	180	—	225	ns
			4.5	—	21	36	—	45	
			6.0	—	18	31	—	38	
Propagation delay time (D/$\overline{U}$ -MAX/MIN)	t_{pLH} t_{pHL}	—	2.0	—	72	160	—	200	ns
			4.5	—	18	32	—	40	
			6.0	—	15	27	—	34	
Maximum clock frequency	f_{max}	—	2.0	5	11	—	4	—	MHz
			4.5	25	44	—	20	—	
			6.0	29	52	—	24	—	
Input capacitance	C_{IN}	—		—	5	10	—	10	pF
Power dissipation capacitance	C_{PD} (Note)	—		—	101	—	—	—	pF

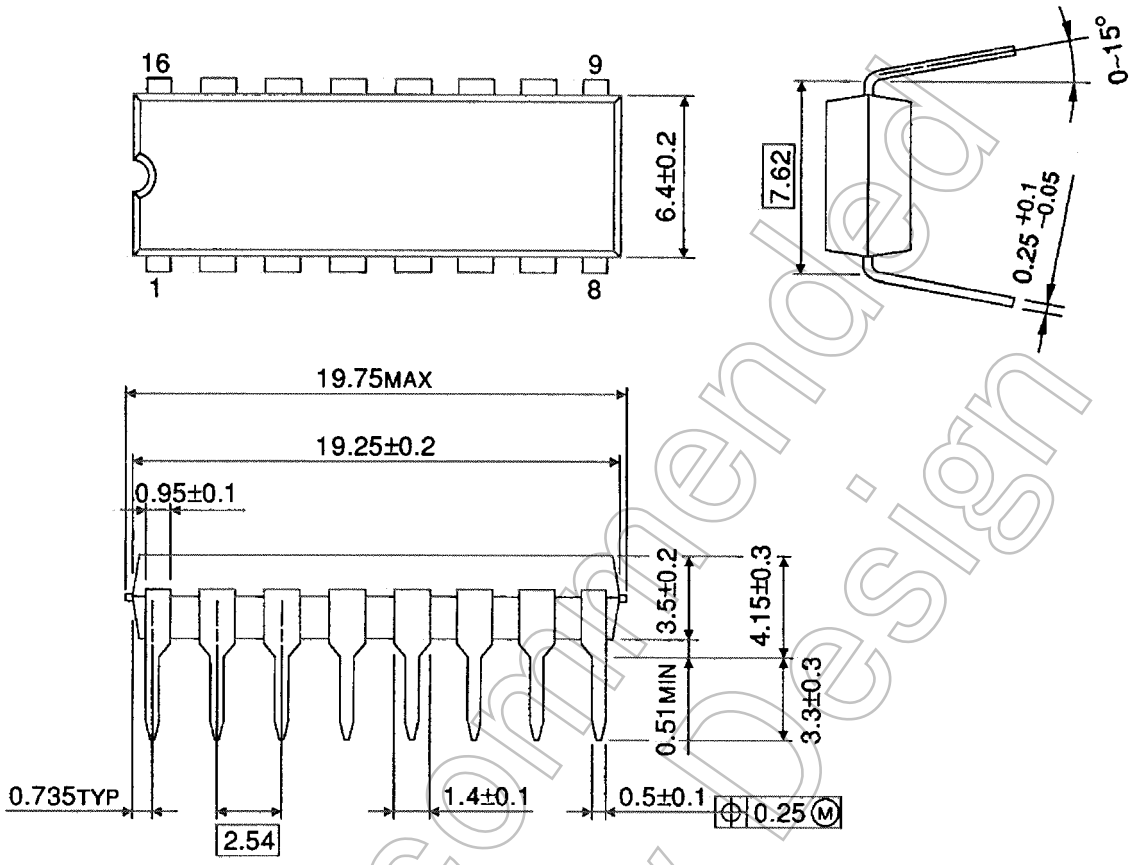
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}\ (opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

Package Dimensions

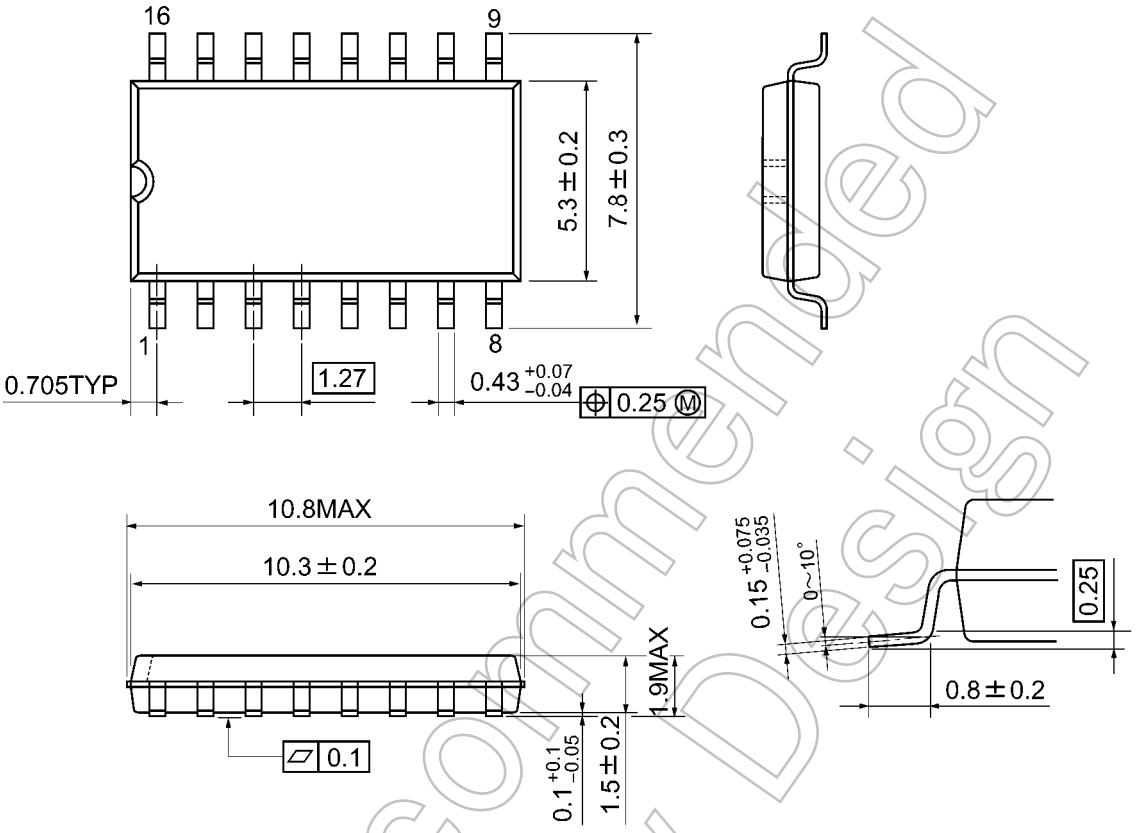
DIP16-P-300-2.54A Unit : mm



Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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